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October 2013

FDPF5N50NZF N-Channel UniFETTM II FRFET[®] MOSFET 500 V, 4.2 A, 1.75 Ω



FDPF5N50NZF — N-Channel UniFETTM II FRFET[®] MOSFET

Features

- $R_{DS(on)}$ = 1.57 Ω (Typ.) @ V_{GS} = 10 V, I_D = 2.1 A
- Low Gate Charge (Typ. 9 nC)
- Low C_{rss} (Typ. 4 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- ESD Improved Capability
- RoHS Compliant

Applications

- LCD/LED TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

Description

UniFETTM II MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on advanced planar stripe and DMOS technology. This advanced MOSFET family has the smallest on-state resistance among the planar MOSFET, and also provides superior switching performance and higher avalanche energy strength. In addition, internal gate-source ESD diode allows UniFET II MOSFET to withstand over 2kV HBM surge stress. The body diode's reverse recovery performance of UniFET II FRFET® MOSFET has been enhanced by lifetime control. Its trr is less than 100nsec and the reverse dv/dt immunity is 15V/ns while normal planar MOSFETs have over 200nsec and 4.5V/nsec respectively. Therefore, it can remove additional component and improve system reliability in certain applications in which the performance of MOSFET's body diode is significant. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

D



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

| o Source Voltag o Source Voltage Current Current | | | 500 ±25 4.2* 2.5* | V V A |
|---|---|---|--|--|
| Current | - Continuous (T _C - Continuous (T _C | | 4.2* | |
| Current | - Continuous (T _C | | | A |
| Current | | = 100°C) | 2.5* | A |
| | - Pulsed | | - | A |
| | | (Note 1) | 16* | А |
| Pulsed Avalanci | Single Pulsed Avalanche Energy | | 165 | mJ |
| Avalanche Current | | (Note 1) | 4.2 | A |
| Repetitive Avalanche Energy | | (Note 1) | 7.8 | mJ |
| Peak Diode Recovery dv/dt | | (Note 3) | 20 | V/ns |
| Dissinction | (T _C = 25 ^o C) | | 30 | W |
| Dissipation | - Derate above 25 | 5°C | 0.24 | W/ºC |
| Operating and Storage Temperature Range | | | -55 to +150 | °C |
| | • | urpose, | 300 | °C |
| | Dissipation ing and Storage um Lead Tempe m Case for 5 S | Dissipation $(T_C = 25^{\circ}C)$ - Derate above 25 ing and Storage Temperature Range | $ \begin{array}{c c} (T_{C} = 25^{\circ}C) \\\hline - \text{ Derate above } 25^{\circ}C \\\hline \text{ing and Storage Temperature Range} \\\hline \text{um Lead Temperature for Soldering Purpose,} \\m Case for 5 Seconds \\\hline \end{array} $ | $\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$ |

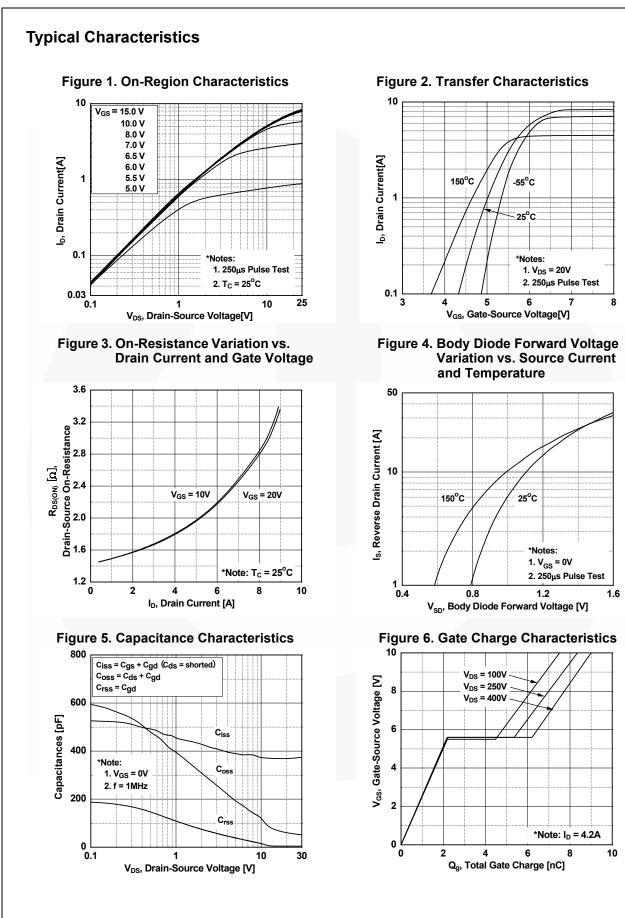
Thermal Characteristics

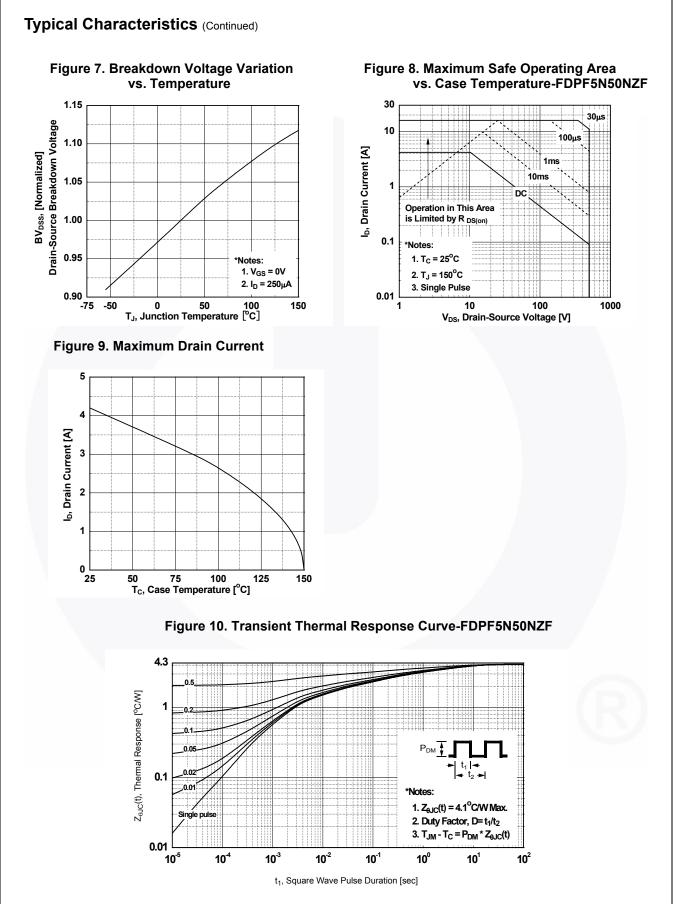
| Symbol | Parameter | FDPF5N50NZF | Unit |
|---------------------|---|---|------|
| $R_{	ext{	heta}JC}$ | Thermal Resistance, Junction to Case, Max. | rmal Resistance, Junction to Case, Max. 4.1 | |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, Max. | 62.5 | °C/W |

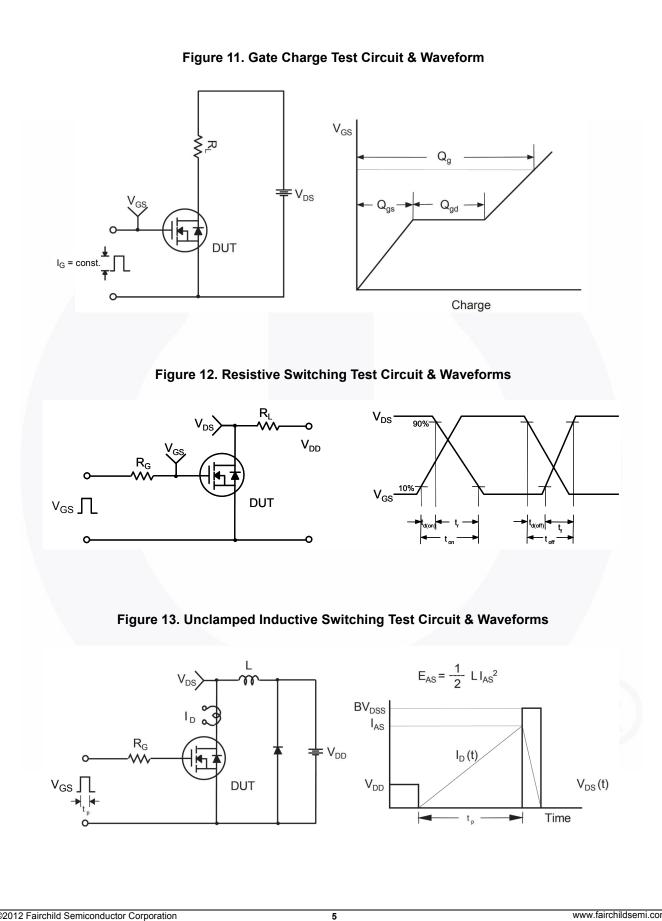
| Device N | - | | Pack | age | Reel Size | Таре | Width | | Quantit | y |
|--|--|---|--|---|---|----------|---|--|--|--|
| FDPF5N | | | TO-2 | 220F Tube | | N/A | | 50 units | | |
| Electric | al Chai | racteristics T _C = | = 25°C unles | ss otherwis | se noted | | | | | |
| Symbol | ool Parameter | | | Test Conditions | | Min. | Тур. | Max. | Unit | |
| Off Chara | acteristic | s | | | | | | | | |
| BV _{DSS} | Drain to Source Breakdown Voltage | | I _D = 250μA, V _{GS} = 0V, T _C = 25 ^o C | | 500 | - | - | V | | |
| ∆BV _{DSS} | | Breakdown Voltage Temperature | | | | | 000 | | | |
| $/\Delta T_{J}$ | Coefficient | | | I _D = 25 | 50µA, Referenced to | 25°C | - | 0.5 | - | V/°C |
| | | | | V _{DS} = | $V_{DS} = 500V, V_{GS} = 0V$ | | - | - | 10 | |
| IDSS | Zero Gate Voltage Drain Current | | ent | V _{DS} = | 400V, V _{GS} = 0V,T _C = | = 125ºC | - | - | 100 | μA |
| I _{GSS} | Gate to | Body Leakage Curre | nt | V _{GS} = | ±25V, V _{DS} = 0V | | - | - | ±10 | μA |
| On Chara | cteristic | s | | | | | | | | |
| V _{GS(th)} | | hreshold Voltage | | V _{GS} = | V _{DS} , I _D = 250μA | | 3.0 | - | 5.0 | V |
| | | Drain to Source On Re | sistance | | 10V, I _D = 2.1A | | - | 1.57 | 1.75 | Ω |
| TDS(on) | | | | | | | | 1 | | |
| _{9FS} Dynamic | Forwar Charact | d Transconductance eristics apacitance | | V _{DS} = | 20V, I _D = 2.1A | | - | 4.2 365 | - 485 | S pF |
| g _{FS} Dynamic C _{iss} C _{oss} | Forwar Charact Input C Output | eristics apacitance Capacitance | | V _{DS} = | 25V, V _{GS} = 0V | | - | 365 50 | 65 | pF pF |
| 9 _{FS} Dynamic C _{iss} C _{oss} C _{rss} | Forwar Charact Input C Output Revers | eristics apacitance Capacitance e Transfer Capacitanc | e | V _{DS} = | 25V, V _{GS} = 0V | | - | 365 50 4 | 65 8 | pF pF pF |
| 9FS Dynamic C _{iss} C _{oss} C _{rss} Q _{g(tot)} | Forwar Charact Input C Output Revers Total G | eristics apacitance Capacitance e Transfer Capacitanc ate Charge at 10V | e | V _{DS} = | 25V, V _{GS} = 0V Hz | | - | 365 50 4 9 | 65 | pF pF pF nC |
| 9FS Dynamic C _{iss} C _{oss} C _{rss} Q _{g(tot)} Q _{gs} | Forwar Charact Input C Output Revers Total G Gate to | eristics apacitance Capacitance e Transfer Capacitanc ate Charge at 10V o Source Gate Charge | e | V _{DS} = | 25V, V _{GS} = 0V Hz 400V I _D = 4.2A | | - | 365 50 4 9 2 | 65 8 | pF pF pF nC nC |
| 9FS Dynamic C _{iss} C _{oss} C _{rss} Q _{g(tot)} | Forwar Charact Input C Output Revers Total G Gate to | eristics apacitance Capacitance e Transfer Capacitanc ate Charge at 10V | e | V _{DS} = | 25V, V _{GS} = 0V Hz 400V I _D = 4.2A | (Note 4) | - | 365 50 4 9 | 65 8 | pF pF pF nC |
| 9FS Dynamic C _{iss} C _{oss} C _{rss} Q _{g(tot)} Q _{gs} Q _{gd} | Forwar Charact Input C Output Revers Total G Gate to Gate to | eristics apacitance Capacitance e Transfer Capacitanc ate Charge at 10V o Source Gate Charge o Drain "Miller" Charge | e | V _{DS} = | 25V, V _{GS} = 0V Hz 400V I _D = 4.2A | (Note 4) | - - - - - - | 365 50 4 9 2 | 65 8 | pF pF pF nC nC |
| g_{FS} Dynamic C_{iss} C_{rss} C_{rss} $Q_{g(tot)}$ Q_{gs} Q_{gd} Switching | Forwar Charact Input C Output Revers Total G Gate to Gate to C C C C C C C C C C C C C C C C C C C | eristics apacitance Capacitance e Transfer Capacitanc ate Charge at 10V o Source Gate Charge o Drain "Miller" Charge | e | V _{DS} = | 25V, V _{GS} = 0V Hz 400V I _D = 4.2A | (Note 4) | - - - - - - | 365 50 4 9 2 | 65 8 | pF pF pF nC nC |
| g_{FS} Dynamic C_{iss} C_{rss} $Q_{g(tot)}$ Q_{gs} Q_{gd} Switching $t_{d(on)}$ | Forwar Fo | eristics apacitance Capacitance e Transfer Capacitanc ate Charge at 10V o Source Gate Charge Drain "Miller" Charge | e | $V_{DS} =$ $V_{DS} =$ $f = 1M$ $V_{DS} =$ $V_{GS} =$ $V_{DD} =$ | 25V, V _{GS} = 0V Hz 400V I _D = 4.2A 10V 250V, I _D = 4.2A | (Note 4) | - - - - - - - - - - - - - - - - - - - | 365 50 4 9 2 4 | 65 8 12 - - | pF pF nC nC |
| 9FS Dynamic C _{iss} C _{oss} C _{rss} Q _{g(tot)} Q _{gs} Q _{gd} Switching t _{d(on)} t _r | Forwar Fo | eristics apacitance Capacitance e Transfer Capacitance ate Charge at 10V o Source Gate Charge Drain "Miller" Charge cteristics n Delay Time | e | $V_{DS} =$ $V_{DS} =$ $f = 1M$ $V_{DS} =$ $V_{GS} =$ $V_{DD} =$ | 25V, V _{GS} = 0V Hz 400V I _D = 4.2A 10V | (Note 4) | | 365 50 4 9 2 4 12 | 65 8 12 - - 35 | pF pF nC nC nC |
| C_{oss} C_{rss} $Q_{g(tot)}$ Q_{gs} Q_{gd} Switching $t_{d(on)}$ | Forwar Fo | eristics apacitance Capacitance e Transfer Capacitance ate Charge at 10V o Source Gate Charge Drain "Miller" Charge cteristics n Delay Time n Rise Time | e | $V_{DS} =$ $V_{DS} =$ $f = 1M$ $V_{DS} =$ $V_{GS} =$ $V_{DD} =$ | 25V, V _{GS} = 0V Hz 400V I _D = 4.2A 10V 250V, I _D = 4.2A | (Note 4) | - | 365 50 4 9 2 4 4 12 19 | 65 8 12 - - 35 50 | pF pF nC nC nC nC |
| g_{FS} Dynamic C_{iss} C_{rss} $Q_{g(tot)}$ Q_{gs} Q_{gd} Switching $t_{d(on)}$ t_r t_q $t_{d(off)}$ t_f | Forwar Fo | eristics apacitance Capacitance e Transfer Capacitance ate Charge at 10V o Source Gate Charge o Drain "Miller" Charge Drain "Miller" Charge cteristics n Delay Time n Rise Time ff Delay Time ff Fall Time | | $V_{DS} =$ $V_{DS} =$ $f = 1M$ $V_{DS} =$ $V_{GS} =$ $V_{DD} =$ | 25V, V _{GS} = 0V Hz 400V I _D = 4.2A 10V 250V, I _D = 4.2A | | - | 365 50 4 9 2 4 4 12 19 31 | 65 8 12 - - 35 50 70 | pF pF nC nC nC nC ns ns |
| g_{FS} Dynamic C_{iss} C_{oss} C_{rss} $Q_{g(tot)}$ Q_{gs} Q_{gd} Switching $t_{d(on)}$ t_r $t_{d(off)}$ t_r Drain-Sou | Forwar Forwar | eristics apacitance Capacitance e Transfer Capacitance ate Charge at 10V Source Gate Charge Drain "Miller" Charge Drain "Miller" Charge cteristics n Delay Time n Rise Time ff Delay Time | :S | $V_{DS} =$ $f = 1M$ $V_{DS} =$ $V_{GS} =$ $V_{GS} =$ $V_{GS} =$ | 25V, $V_{GS} = 0V$ Hz 400V $I_D = 4.2A$ 10V 250V, $I_D = 4.2A$ 10V, $R_{GEN} = 25\Omega$ | | - | 365 50 4 9 2 4 4 12 19 31 | 65 8 12 - - 35 50 70 | pF pF nC nC nC nC ns ns |
| 9 _{FS} Dynamic C _{iss} C _{oss} C _{rss} Q _{g(tot)} Q _{gs} Q _{gd} Switching t _{d(on)} t _r t _{d(off)} t _f Drain-Sou I _s | Forwar Fo | eristics capacitance capacitance e Transfer Capacitance ate Charge at 10V o Source Gate Charge o Drain "Miller" Charge cteristics n Delay Time n Rise Time ff Delay Time ff Fall Time de Characteristic | Source Did | $V_{DS} =$ $V_{DS} =$ $f = 1M$ $V_{DS} =$ $V_{GS} =$ $V_{GS} =$ $V_{GS} =$ $V_{GS} =$ $V_{GS} =$ | $25V, V_{GS} = 0V$ Hz $400V I_D = 4.2A$ 10V $250V, I_D = 4.2A$ $10V, R_{GEN} = 25\Omega$ rd Current | | - | 365 50 4 9 2 4 4 12 19 31 | 65 8 12 - - 35 50 70 55 | pF pF nC nC nC nS ns ns ns |
| 9 _{FS} Dynamic C _{iss} C _{oss} C _{rss} Q _{g(tot)} Q _{gs} Q _{gd} Switching t _{d(on)} t _r t _{d(off)} t _f Drain-Sou I _S I _{SM} | Forwar Fo | eristics capacitance Capacitance e Transfer Capacitance ate Charge at 10V Source Gate Charge Drain "Miller" Charge teristics n Delay Time n Rise Time ff Delay Time ff Fall Time de Characteristic un Continuous Drain to | Source Did urce Diode F | $V_{DS} =$ $V_{DS} =$ $f = 1M$ $V_{DS} =$ $V_{GS} =$ $V_{GS} =$ $V_{GS} =$ $V_{GS} =$ $V_{GS} =$ $V_{GS} =$ | $25V, V_{GS} = 0V$ Hz $400V I_D = 4.2A$ $10V$ $250V, I_D = 4.2A$ $10V, R_{GEN} = 25\Omega$ rd Current urrent | | - | 365 50 4 9 2 4 4 12 19 31 | 65 8 12 - - 35 50 70 55 4.2 | pF pF nC nC nC nS ns ns ns |
| g_{FS} Dynamic C_{iss} C_{rss} $Q_{g(tot)}$ Q_{gs} Q_{gd} Switching $t_{d(on)}$ t_r t_q $t_{d(off)}$ t_f | Forwar Fo | eristics capacitance Capacitance e Transfer Capacitance ate Charge at 10V o Source Gate Charge o Drain "Miller" Charge cteristics n Delay Time n Rise Time ff Delay Time ff Fall Time de Characteristic um Continuous Drain to source Capacitance ff Fall Time | Source Did urce Diode F | $V_{DS} =$ $V_{DS} =$ $f = 1M$ $V_{DS} =$ $V_{GS} =$ | $25V, V_{GS} = 0V$ Hz $400V I_D = 4.2A$ 10V $250V, I_D = 4.2A$ $10V, R_{GEN} = 25\Omega$ rd Current | | - - - - | 365 50 4 9 2 4 4 12 19 31 22 - - | 65 8 12 - - 35 50 70 55 4.2 16 | pF pF nC nC nC nC nS ns ns ns A A |

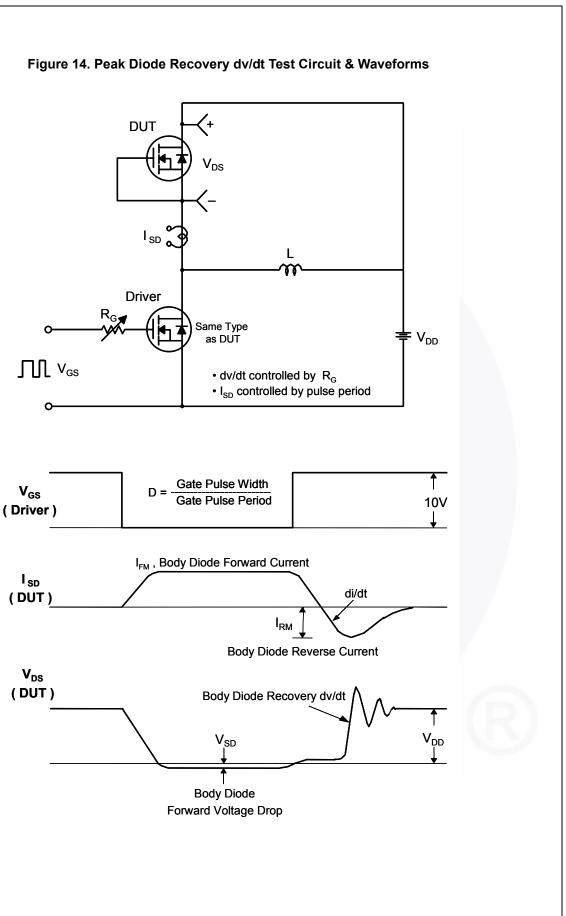
 $\begin{array}{l} 3. \ I_{SD} \leq 4.2A, \ di/dt \leq 200A/\mu s, \ V_{DD} \leq BV_{DSS}, \ Starting \ T_J = 25^\circ C \\ \ 4. \ Essentially \ Independent \ of \ Operating \ Temperature \ Typical \ Characteristics \\ \end{array}$

FDPF5N50NZF — N-Channel UniFETTM II FRFET[®] MOSFET

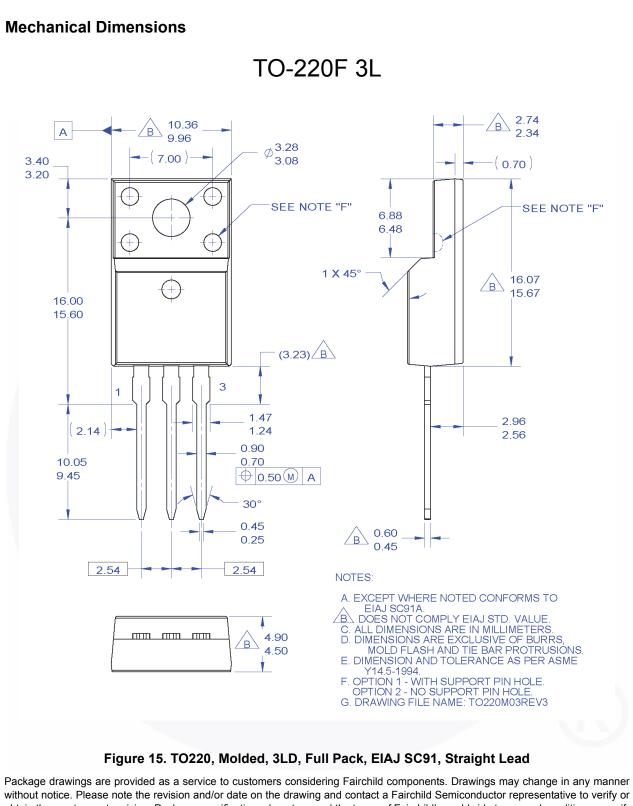








FDPF5N50NZF — N-Channel UniFETTM II FRFET[®] MOSFET



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Dimension in Millimeters

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